

SPECIFICATIONS

CUSTOMER : PTC

SAMPLE CODE : SH480272T009-IBF01

MASS PRODUCTION CODE : PH480272T009-IBF01

SAMPLE VERSION : 02

SPECIFICATIONS EDITION : 006

DRAWING NO. (Ver.) : JLMD-PH480272T009-IBF01_005

PACKAGING NO. (Ver.) : JPKG- PH480272T009-IBF01_002

Customer Approved Date:

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☐ Preliminary specification for design input

■ Specification for sample approval

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History of Version

Date	Ver.	Edi.	Description	Page	Design by
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				-	

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Note: For detailed information please refer to IC data sheet:ILITEK--- ILI6480B



1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	a-Si TFT , Normally White , TN mode , Transmissive type
Screen size(inch)	4.3"(Diagonal)
Viewing Direction	6 O'clock
Color configuration	R,G, B vertical stripe
Display Interface	Digital 24-bits RGB
Driver IC	ILI6480B
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	115.1(W) x 73.9 (L) x 5.525(H)	mm

LCD panel

Item	Standard Value		
Viewing Area	96.7 (W) * 55.3 (L)	mm	
Active Area	95.04 (W) x 53.856 (L)	mm	
Pixel Size	0.198 (W) * 0.198 (H)	mm	

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDD	GND=0	-0.5	+5.0	٧
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C
Storage Humidity	H _D	Ta ≤ 60 °C	10	90	%RH

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = $25^{\circ}C$

			_	- , -	
Symbol	ymbol Condition Min.		Тур.	Max.	Unit
VDD	-	3.0	3.3	3.6	٧
VGH	-	-	15	-	V
VGL		-	-10	-	V
ViH	-	0.7*VDD	-	VDD	V
VIL	-	GND	-	0.3* GND	V
Vон	-	VDD-0.4	-	VDD	V
Vol	-	GND	-	GND +0.4	V
IDD	VDD=3.3V *1	-	15	25	mA
	VDD VGH VGL VIH VIL VOH VOL	VDD - VGH - VGL - VIH - VIL - VOH - VOL -	VDD - 3.0 VGH - - VGL - - VIH - 0.7*VDD VIL - GND VOH - VDD-0.4 VOL - GND	VDD - 3.0 3.3 VGH - - 15 VGL - - -10 VIH - 0.7*VDD - VIL - GND - VOH - VDD-0.4 - VOL - GND -	VDD - 3.0 3.3 3.6 VGH - - 15 - VGL - - -10 - VIH - 0.7*VDD - VDD VIL - GND - 0.3* GND VOH - VDD-0.4 - VDD VOL - GND - GND +0.4

Note1: Maximum current display.





1.5 Optical Characteristics

TFT LCD Panel

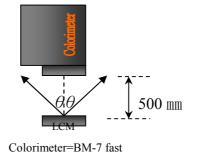
VDD =3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Response tin	ne	Tr + Tf	-	-	30	45	ms	Note2
	Тор	θ+		-	80	-		
\/ioving onglo	Bottom	θ-	CR ≥ 10	-	80	-	Dog	Note 4
Viewing angle	Left	θL	CR 2 10	-	80	-	Deg.	Note4
	Right	θR		-	80	-		
Contrast rati	0	CR		300	500	-	-	-
	\	Х		0.27	0.32	0.37		
	White	Υ		0.29	0.34	0.39		,
0.1	Dod	Х		0.52	0.57	0.62		
Color of CIE Coordinate	Red	Υ	IF= 20 mA	0.29	0.34	0.39		Note1
(With B/L & TP)	Green	Х		0.29	0.34	0.39	_	NOLET
(**************************************	Green	Υ		0.56	0.61	0.66		
	Blue	X		0.10	0.15	0.20		
	Diue	Y		0.03	0.08	0.13		
Average Brighti	ness							
Pattern=white display		IV	IF= 20 mA	420	460	-	cd/m ²	Note1
(With B/L & TP)								
Uniformity		∆B	IF= 20 mA	70	_	_	%	Note1

Note1:

- $1 : \triangle B=B(min) / B(max) \times 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta=0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d : The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



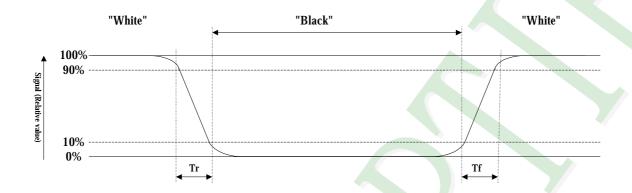




Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

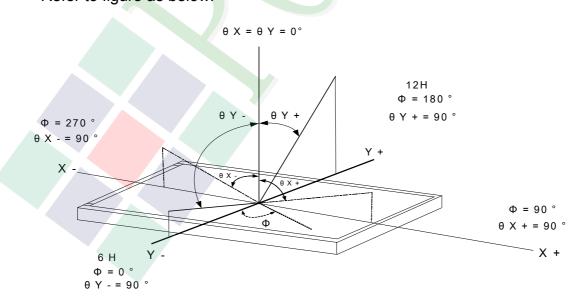
Contrast ratio is calculated with the following formula

Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current (Each LED)	IF	Ta =25°C	-	30	mA
LED Reverse Voltage (Each LED)	VR	Ta =25°C	- 🙏	5.0	V
Power Dissipation	PD	Ta =25°ℂ		90*7	mW

Electrical / Optical Characteristics

-						
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		18.2	22.8	24.5	V
Average Brightness (Without LCD)	IV	IF=20mA	6000	7200	9600	cd/m ²
CIE Color Coordinate	X		0.26	0.30	0.33	
(Without LCD)	Y		0.26	0.30	0.33	-
Color			White			

Internal Circuit Diagram



Other Description

Item	Conditions	Description
Life Time	Ta =25°ℂ	20000 hrs
Life Time	IF= 20mA	20000 hrs



1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	4.3"
Touch type	Projective capacitive touch panel
roden type	True Multi-touch with up to 5 Points of Absolution
Output Interface	I ² C
IC	FT5426

Mechanical Specifications

Item	Standard Value	Unit
Viewing Area	97.10 mm (W) x 55.90 mm (H)	mm
Number of sensing channel		mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	T _{ST}	-	-30	+80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDD	-	2.8	3.3	3.6	V

Optical Characteristics

Item	Standard Value	Unit
Total light transmittance	85% or more	-
Haze	3% or less	-

PIN Definition

Pin No.	Symbol	Function
1	GND	Ground
2	SDA	I ² C Data
3	SCL	I ² C Clock



4	VDD	Digital I/O Power Can be Set as VDD
5	INT	Interrupt Output
6	nRST	Chip Reset Input, Negative Edge Trigger

I²C Read/Write Interface description

Write N bytes to I2C slave

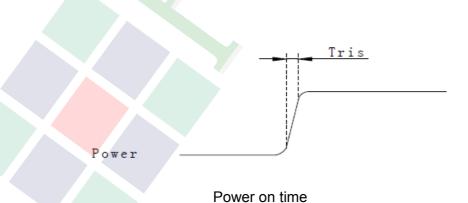
Data [X+N-1]					[Z	a [2	Dat						ss[]	ires	Add	ta A	Da	- 1				ir	Add	re A	lav	5		
O D D D D D D D D D A 6 5 4 3 2 1 0 A	D D	A	D 0	D 1	D 2	D 3	D 4) D) I	A I	R 0	R 1	R 2	R 3	R 4	R 5	R 6	R 7	A	R W	A 0	A 1	A 2	A 3	A 4	A 5	A 6	s
AC.		AC								AC									AC	WRI								STA
		ACK								ACK									ACK	VRITE								TART

Set Data Address

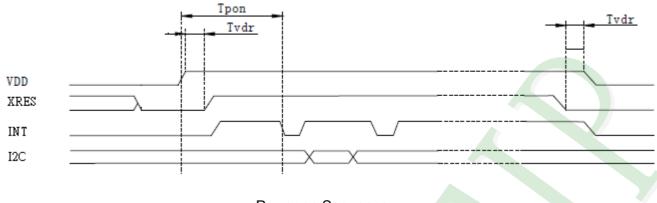
		5	Slav	ve .	Add	lr					Da	ta A	Ado	lre	ss[]	[X]			
s	A 6	A 5	A 4	A 3	A 2	A 1	A 0	R W	A	R 7	R 6	R 5	R 4	R 3	R 2	R 1	R 0	A	P
START								WRITE	ACK									ACK	STOP

Read X bytes from I2C Slave

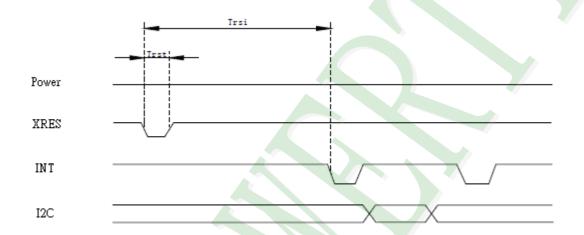








Power on Sequence



Reset Sequence

Power on / Reset Sequence Parameters

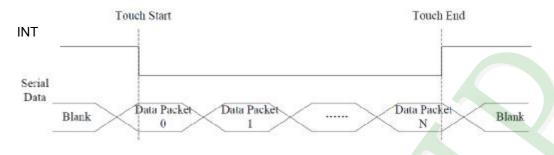
Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD	1 55 1	5	ms
Tpon	Time of starting to report point after powering on	200		ms
Tvdr	Reset time after VDD powering on	1	223	ms
Trsi	Time of starting to report point after resetting	200	22 22.73	ms
Trst	Reset time	1		ms

Interrupt signal from CTP to Host

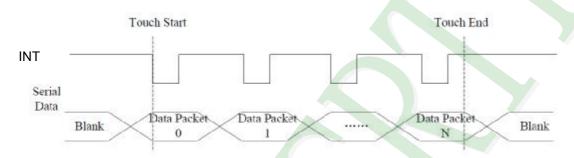
As for standard CTP, host need to use both interrupt control signal and serial data interface to get the touch data. There are two kind of method to use interrupt: interrupt trigger and interrupt query.

Here is the timing to get touch data.





Interrupt query mode



Interrupt trigger mode

Host use general I2C protocol to read the touch data or the information from CTP. CTP will send host a interrupt signal when there is a valid touch. Then host can use the serial data interface to get the touch data. If there is no valid touch detected, the INT will not be pulled up, the host do not need to read the touch data

NOTE: "valid touch" may have different definition in various systems. For example, in some systems, the valid touch is defined as there is one more valid touch point. But in some other systems, the valid touch is defined as one more valid touch with valid gestures. In usual, INT will be pulled up when there is a valid touch point, and to be low when a touch finishes.

As for interrupt trigger mode, INT signal will be low if there is a touch detected. But for per update of valid touch data, CTP will produce a valid pulse for INT signal, host can read the touch data periodically according to the frequency of this pulse. In this mode, the pulse frequency is the touch data update frequency.

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CTP Register Mapping

Address	Name	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Host Access
Op,00h	DEVIDE_MODE		Device	Mode[2:	0]		•			RW
Op,01h	GEST_ID	Gesture	ID[7:0]			100				R
Op,02h	TD_STATUS					Numbe	r of touc	h points[3	[0:0]	R
Op,03h	TOUCH1_XH	1st Ever	t Flag			1st Tou	ch X Pos	ition[11:8]	R
Op,04h	TOUCH1_XL	1st Touc	h X Posi	tion[7:0]						R
Op,05h	TOUCH1_YH	1st Touc	h ID[3:0]		1st Tou	ch Y Pos	ition[11:8]	R
Op,06h	TOUCH1_YL	1 st Touc	h Y Posi	tion[7:0]		*				R
Op,07h	Reserved									3 8
Op,08h	Reserved									. B
Op,09h	TOUCH2_XH	2 nd Eve	nt Flag			2 nd tou	ch X Pos	ition[11:8]	R
Op,0Ah	TOUCH2_XL	2 nd touc	h X Posi	tion[7:0]						R
Op,0Bh	TOUCH2_YH	2 nd Tou	ch ID[3:0	0]		2 nd Tou	ich Y Pos	sition[11:	8]	R
Op,0Ch	TOUCH2_YL	2 nd Tou	ch Y Pos	ition[7:0]						R
Op,0Dh	Reserved									3
Op,0Eh	Reserved									R
Op,0Fh	TOUCH3_XH	3 st Ever	t Flag			3st Tou	ch X Pos	ition[11:8]	R
Op,10h	TOUCH3_XL	3 st Touc	h X Posi	tion[7:0]						R
Op,11h	TOUCH3_YH	3 st Touc	h ID[3:0]		3st Tou	ch Y Pos	ition[11:8]	R
Op,12h	TOUCH3_YL	3 st Touc	h Y Posi	tion[7:0]						R
Op,13h	Reserved									
Op,14h	Reserved					ave.				
Op,15h	TOUCH4_XH	4 st Ever	t Flag			4 st Tou	ch X Pos	ition[11:8]	R
Op,16h	TOUCH4_XL	4st Touc	h X Posi	tion[7:0]	53	100				R
Op,17h	TOUCH4_YH	4st Touc	h ID[3:0]		4st Tou	ch Y Pos	ition[11:8]	R
Op,18h	TOUCH4_YL	4st Touc	h Y Posi	tion[7:0]		.10				R
Op,19h	Reserved									
Op,1Ah	Reserved									



Op,1Bh	TOUCH5_XH	5st Event Flag	5st Touch X Position[11:8]	R
Op,1Ch	TOUCH5_XL	5st Touch X Position[7:	0]	R
Op,1Dh	TOUCH5_YH	5st Touch ID[3:0]	5st Touch Y Position[11:8]	R
Op,1Eh	TOUCH5_YL	5st Touch Y Position[7:	0]	R
Op,1Fh	Reserved			
Op,20h	Reserved			
Op,21h	TOUCH6_XH	6st Event Flag	6st Touch X Position[11:8]	R
Op,22h	TOUCH6_XL	6st Touch X Position[7:	0]	R
Op,23h	TOUCH6_YH	6st Touch ID[3:0]	6st Touch Y Position[11:8]	R
Op,24h	TOUCH6_YL	6st Touch Y Position[7	0]	R
Op,25h	Reserved			
Op,26h	Reserved			
Op,27h	TOUCH7_XH	7st Event Flag	7st Touch X Position[11:8]	R
Op,28h	TOUCH7_XL	7st Touch X Position[7	0]	R
Op,29h	TOUCH7_YH	7st Touch ID[3:0]	7st Touch Y Position[11:8]	R
Op,2Ah	TOUCH7_YL	7st Touch Y Position[7	0]	R
Op,2Bh	Reserved			
Op,2Ch	Reserved			3.5
Op,2Dh	TOUCH8_XH	8st Event Flag	8st Touch X Position[11:8]	R
Op,2Eh	TOUCH8_XL	8st Touch X Position[7	0]	R
Op,2Fh	TOUCH8_YH	8st Touch ID[3:0]	8st Touch Y Position[11:8]	R
Op,30h	TOUCH8_YL	8st Touch Y Position[7:	0]	R
Op,31h	Reserved			3 8
Op,32h	Reserved			38
Op,33h	TOUCH9_XH	9st Event Flag	9st Touch X Position[11:8]	R
Op,34h	TOUCH9_XL	9st Touch X Position[7:	0]	R
Op,35h	TOUCH9_YH	9st Touch ID[3:0]	9st Touch Y Position[11:8]	R
Op,36h	TOUCH9_YL	9st Touch Y Position[7:	0]	R
Op,37h	Reserved			4.5
Op,38h	Reserved			
Op,39h	TOUCH10_XH	10st Event Flag	10st Touch X Position[11:8]	R
Op,3Ah	TOUCH10_XL	10st Touch X Position[7:0]	R
Op,3Bh	TOUCH10 YH	10st Touch ID[3:0]	10st Touch Y Position[11:8]	R



Op,3Ch	TOUCH10_YL	10st Touch Y Position[7:0]	R
Op,3Dh	Reserved		
Op,3Eh	Reserved		
	•••		
Op,FEh	LOG_MSG_CNT	The log MSG count	R
Op,FFh	LOG_CUR_CHA	Current character of log message, will point to the next character when one character is read.	R

DEVICE MODE

This register is the device mode register, user the get current the device mode.

Bit Address	Register Name Description			
6:4	Device Mode[2:0]	000b Normal operating Mode 001b System Information Mode (Reserved)		
		001b System Information Mode (Reserved) 100b Test Mode – read raw data (Reserved)		

GEST ID

This register describes the gesture of a valid touch.

Bit Address	Register Name	Description
7:0	Gesture ID[7:0]	Gesture ID
		0x10 Single Touch Pan North
		0x14 Single Touch Pan East
		0x18 Single Touch Pan South
		0x1C Single Touch Pan West
		0x20 Single Touch Single Click
		0x22 Single Touch Double Click
		0x28 Single Touch Rotate Clockwise
		0x29 Single Touch rotate Counter Clockwise
		0x40 Zoom In
		0x49 Zoom Out

TD STATUS

This register is the Touch Data status register.

Bit Address	Register Name	Description	
3:0	Number of touch points[3:0]	How many points detected. 1-5 is valid.	



TOUCHn XH (n:1-10)

This register describes MSB of the X coordinate of the nth touch point and the corresponding event flag.

Bit Address	Register Name	Description
7:6	Event Flag	00b: Put Down 01b: Put Up 10b: Contact 11b: Reserved
5:4		Reserved
3:0	Touch X Position[11:8]	MSB of Touch X Position in pixels

TOUCHn_XL (n:1-10)

This register describes LSB of the X coordinate of the nth touch point.

Bit Address	Register Name	Description
7:0	Touch X Position[7:0]	LSB of the Touch X Position in pixels

TOUCHn YH (n:1-10)

This register describes MSB of the Y coordinate of the nth touch point and corresponding touch ID.

Bit Address	Register Name	Description
7:4	Touch ID[3:0]	Touch ID of Touch Point
3:0	Touch X Position[11:8]	MSB of Touch Y Position in pixels

TOUCHn YL (n:1-10)

This register describes LSB of the Y coordinate of the nth touch point.

Bit Address	Register Name	Description
7:0	Touch X Position[7:0]	LSB of The Touch Y Position in pixels

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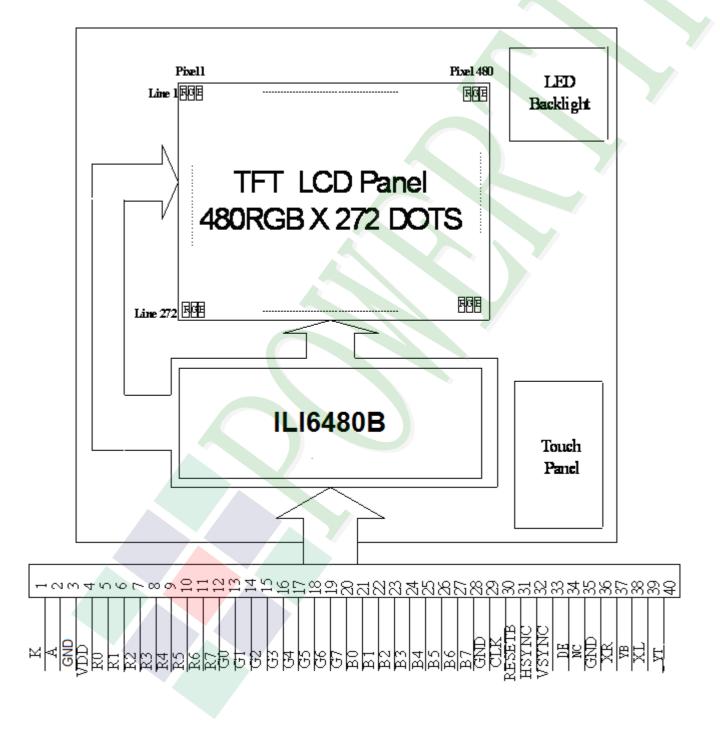
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	K	Power supply for LED Backlight cathode input
2	Α	Power supply for LED Backlight anode input
3	GND	Ground
4	VDD	Digital power
5	R0	Red data bit 0
6	R1	Red data bit 1
7	R2	Red data bit 2
8	R3	Red data bit 3
9	R4	Red data bit 4
10	R5	Red data bit 5
11	R6	Red data bit 6
12	R7	Red data bit 7
13	G0	Green data bit 0
14	G1	Green data bit 1
15	G2	Green data bit 2
16	G3	Green data bit 3
17	G4	Green data bit 4
18	G5	Green data bit 5
19	G6	Green data bit 6
20	G7	Green data bit 7

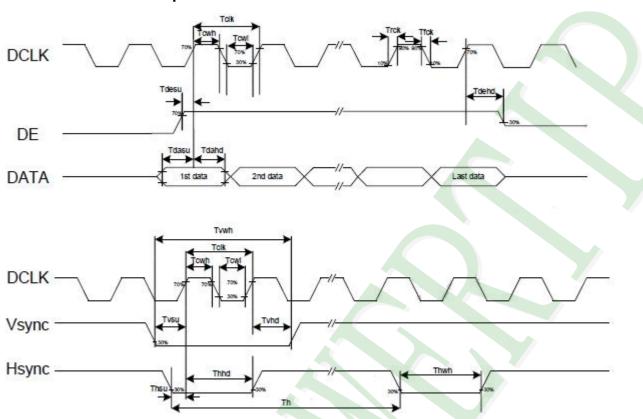


Pin No.	Symbol	Function
21	В0	Blue data bit 0
22	B1	Blue data bit 1
23	B2	Blue data bit 2
24	В3	Blue data bit 3
25	B4	Blue data bit 4
26	B5	Blue data bit 5
27	В6	Blue data bit 6
28	В7	Blue data bit 7
29	GND	Ground
30	CLK	Dot data clock
31	DISP	Display control / standby mode selection "High" : Normal display
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	DE	Data input enable. Active High to enable the data input
35	N.C	Not Connect.
36	GND	Ground
37	XR	Not Connect.
38	YB	Not Connect.
39	XL	Not Connect.
40	YT	Not Connect.



2.3 Timing Characteristics

2.3.1 Clock and Data Input Waveforms



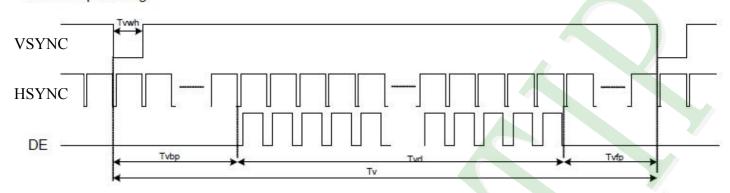


Parameters	Symbol	Min.	Тур.	Max.	Unit	Conditions
System operation timing				·	150	
VDD power source slew time	TPOR	040	-	20	ms	From 0V to 99% VDD
GRB pulse width	tRSTW	10	50	=	us	R=10Kohm, C=1uF
Input Output timing				*		
DCLK clock time	Tclk	33.3	12	-	ns	DCLK=30MHz
DCLK clock low period	Tcwl	40		60	%	
DCLK clock high period	Tcwh	40	0.70	60	%	
Clock rising time	Trck	9	12	= /	ns	
Clock falling time	Tfck	9		*	ns	U
HSD width	Thwh	1	0.70		DCLK	
HSD period time	Th	55	60	65	us	
HSD setup time	Thsu	12	8.57		ns	
HSD hold time	Thhd	12	-	-	ns	
VSD width	Tvwh	1			Th	
VSD setup time	Tvsu	12		1	ns	
VSD hold time	Tvhd	12		5	ns	
Data setup time	Tdasu	12		=	ns	
Data hold time	Tdahd	12	1000	32	ns	
DE setup time	Tdesu	12	-	8	ns	
DE hold time	Tdehd	12	-		ns	
Source output setting time	Tsst	1 (-)		TBD	us	10% to 90% CL=60pF, RL=2Kohm
Gate output setting time	Tgst		1-1	1200	ns	10% to 90%, CL=60pF
VCOM output setting time	Tcst			TBD	us	10% to 90%, CL=40nF, RL=50ohm
Time from VSD to 1st line data input	Tvs	3	8	31	Th	HV mode By HDL[4:0] setting

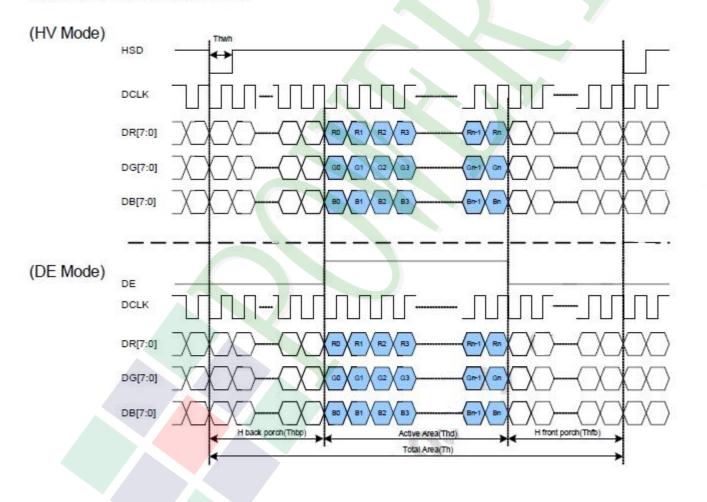


2.3.2 Data Input Format

Vertical input timing



Parallel RGB Mode Data format





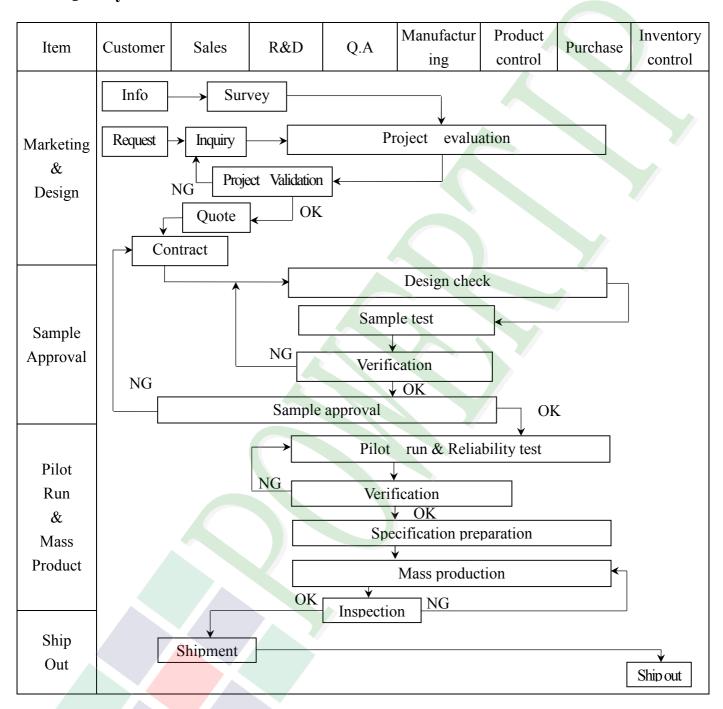
Parallel RGB input timign table

Parameters	Symbol	Value			Unit
		Min.	Тур.	Max.	
DCLK frequency	Fclk	5	9	12	MHz
VSYNC period time	Tv	277	288	400	Н
VSYNC display area	Tvd		272		Н
VSYNC back porch	Tvb	3	8	31	Ξ
VSYNC front porch	Tvfp	2	8	97	Н
HSYNC period time	Th	520	525	800	DCLK
HSYNC display area	Thd		480		DCLK
HSYNC back porch	Thbp	36	40	255	DCLK
HSYNC front porch	Thfp	4	5	65	DCLK

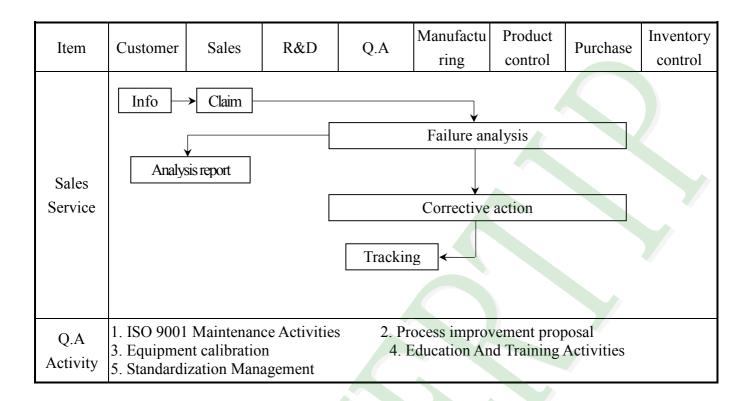


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3, 5" ~10" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge · MIL-STD · Powertip Tester · Sample

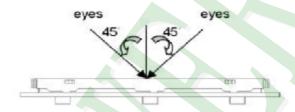
◆Defect Level: Major Defect AQL: 0.4 ; Minor Defect AQL: 1.5

♦OUT Going Defect Level: Sampling.

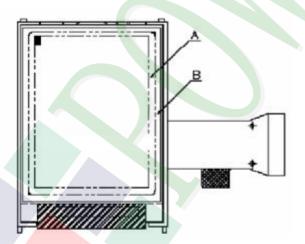
Standard of the product appearance test :

a. Manner of appearance test:

- (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
- (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3, 5" ~10": (Ver.B01)

NO	Item	Criterion	Level			
		1. 1The part number is inconsistent with work order of production.	Major			
01	Product condition	1. 2 Mixed product types.	Major			
		1. 3 Assembled in inverse direction.	Major			
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	re Major			
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.				
04	Electrical Testing	4. 3 Display malfunction.				
		4. 4 LCD viewing angle defect.				
		4, 5 Current consumption exceeds product specifications.	Major			
		Item Acceptance (Q'ty)				
	Dot defect	Bright Dot ≤ 4				
		Dot Dark Dot ≤ 5				
05	(Bright dot \	Defect Joint Dot ≤ 3	M			
05	Dark dot)	Total ≤ 7	Minor			
	On -display	5. 1 Inspection pattern : full white , full black , Red , Green an	ાત			
		blue screens.				
		5. 2 It is defined as dot defect if defect area $>1/2$ dot.				
		5, 3 The distance between two dot defect ≥5 mm.				

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◆Specification For TFT-LCD Module 3. 5″ ~10″ : (Ver.B					
NO	Item	Criterion			
	6.	l Round type (Non-display or display) :			
		Dimension (diameter : Φ)			
	Black or white dot x scratch x	$\Phi \le 0.25$ Ignore			
	contamination	$0.25 < \Phi \le 0.50$ 5 Ignore			
	Round type → ← .	$\Phi > 0.50$			
	X Y	Total 5			
06	6, 2 Line type(Non-display or display) : $\Phi = (x+y) / 2$				
	¥-(x+y)+2	Length (L) Width (W) Acceptance (Q'ty)			
	Line type	A area B area			
	→ M W	$W \le 0.03$ Ignore $L \le 10.0$ $0.03 < W \le 0.05$ 4			
	→ _{I.}	L ≤ 5.0 0.05 < W ≤ 0.10 2 Ignore			
		W > 0.10 As round type			
		Total 5			
	Polarizer Bubble	Dimension (diameter : Φ)			
		Φ ≤ 0.25 Ignore			
07		$0.25 < \Phi \le 0.50$ 4	Minor		
		$0.50 < \Phi \leq 0.80$ 1 Ignore			
		$\Phi > 0.80$			
		Total 5			



◆Specification For TFT-LCD Module 3.5" ~10":

(Ver.B01)

NO	Ttem	Criterion		
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass Y: The width of crack W: terminal length a: LCD side length		
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack between panels:		
08	The crack of glass	SP SP [NG]	Minor	
		Seal width 7.		
		\dot{x} Y z $\leq a$ Crack can't enter $\leq 1/2 t$ Viewing area $\leq 1/2 t$		
		\leq a Crack can't exceed the half of SP width. 1/2 t < Z \leq 2 t		



◆Specification For TFT-LCD Module 3. 5" ~10": (Ver.B01)

NO	Item	Criterion L			Level	
Z: The thickness of crack W: to				W: tern	width of crack. ninal length side length	
		8. 1. 2 Corner crack:				
		X	Y		Z	
		≤1/5 a	Crack can't viewing a		≤ 1/2 t	
		≤1/5 a	Crack can't exc half of SP w		< Z ≤ 2 t	
08	08 The crack of glass 8. 2 Protrusion over terminal: 8. 2. 1 Chip on electrode pad:				<u> </u>	Mino
00					.,,,,,,,,	
		W.Y.	X	z X	y z	
				X		
			X	Y	Z	
		Front	≤ a	≤ 1/2 W	≦ t	
		Back	≤ a	≦ W	$\leq 1/2 t$	1



◆Specification For TFT-LCD Module 3. 5" ~10":

(Ver.B01)

NO	Item	Criterion		
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length S: 2. 2 Non-conductive portion:	-	
		8. 2. 2 Non-conductive portion		
08	The crack of	$\begin{array}{c cccc} X & & & & & X \\ \hline & X & & Y & & Z \\ \hline & \leq 1/3 & a & \leq W & & \leq t \end{array}$	Minor	
	glass	⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode		
		terminal specifications.		
		8. 2. 3 Glass remain : Y W Pitch		
		$\begin{array}{c cccc} X & Y & Z \\ & \leq a & \leq 1/3 \text{ W} & \leq t \end{array}$		



◆Specification For TFT-LCD Module 3. 5" ~10": (Ver.B01)

NO	Item	Criterion	
09	9. 1 Backlight can't work normally. 9. 2 Backlight doesn't light or color is wrong. 9. 3 Illumination source flickers when lit.		Level Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
10	General appearance	10. 1 Pin type \quantity \quantity \dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC .	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	Major
		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is $\leq 1, 5$ mm.	Minor

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4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

	(Tollbur)			
NO.	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.		
2	Low Temperature Storage Test	Keep in - 30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.		
3	High Temperature / High Humidity Storage Test	Keep in +60°C /90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs.		
	Temperature Cycling	- 30°C → +25°C	→ +80°C → +25°C	
4		(30mins) (5mins)	(30mins) (5mins)	
1	Storage Test	10	Cycle	
		Surrounding temperature, then st	orage at normal condition 4hrs.	
	ESD Test	Air Discharge:	Contact Discharge:	
		Apply 15 KV with 10 times	Apply 10 V with 10 times	
		Discharge for each polarity +/-	discharge for each polarity +/-	
		1. Temperature ambiance : 15°C ~35°C		
5		2. Humidity relative: 30%~60%		
		 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330Ω±10% 		
		5. Discharge, mode of operation a		
			successive discharges at least 1 sec)	
		9 ,	, ,	
		(Tolerance if the output voltage indication: ±5%) 1. Sine wave 10∼55 Hz frequency (1 min/sweep)		
6	Vibration Test (Packaged)	2. The amplitude of vibration :1.	• ` •	
		3. Each direction (X \ Y \ Z) du		
	Drop Test (Packaged)			
		Packing Weight (Kg	, <u>1</u>	
			122	
7		45. 4 ~ 90. 8	76	
		90. 8 ~ 454	61	
		Over 454	46	
		Drop Direction: **1 corner / 3 edg	es / 6 sides each 1time	



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

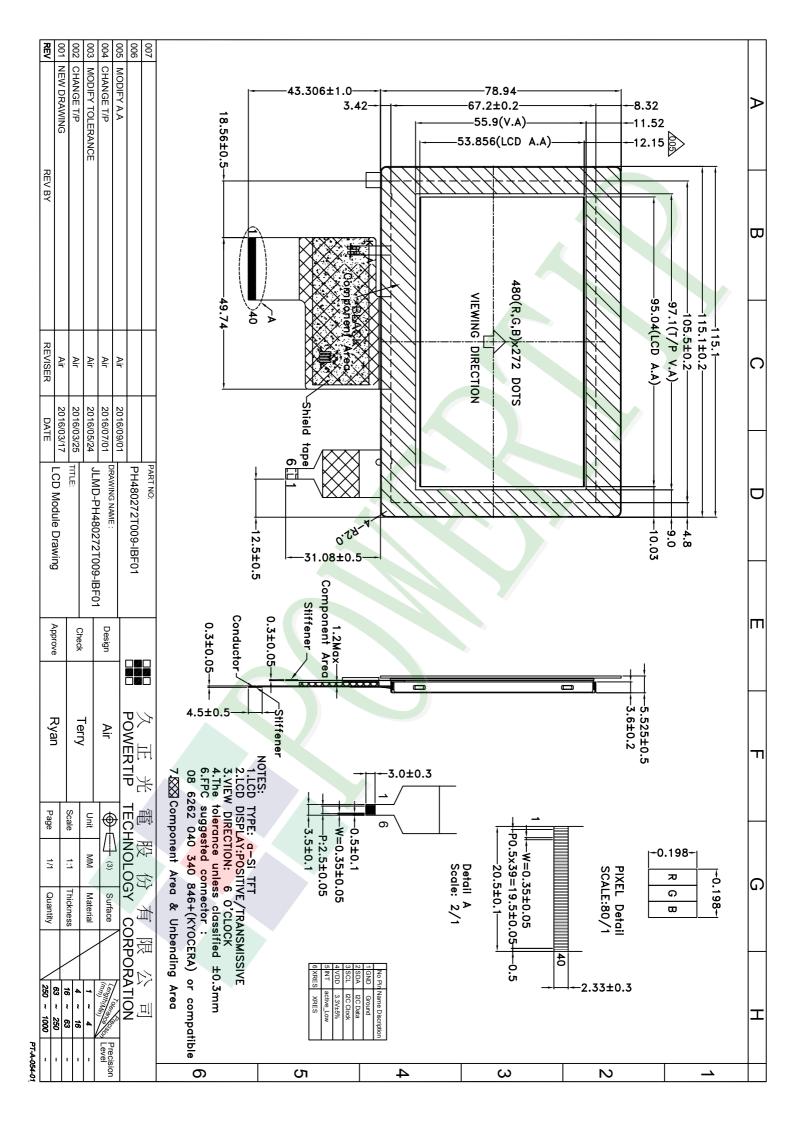
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 - The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Ryan Documents NO. JPKG-PH480272T009-IBF01 Air Terry (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) Dimensions (mm) 1Pcs Weight No. Item Model Quantity Total Weight 1 成品 (LCM) 144 PH480272T009-IBF01 115.1X73.9X5.525 0.0781 11.2464 2 多層薄膜(1)POF 6 OTFILM0BA03ABA 19"X350X0.015 3 TRAY 盤 (2)Tray TY0000000381 352 X 260 X 13.5 42 4.2 0.1 4 内盒(3)Product Box BX36627063ABBA 0.182 6 1.092 383 X 270 X 66 OTPLB00PL08ABA 0.0284 2 0.0568 5 保利龍板(4)Polylon board 550 X 393 X 20 外紙箱(5)Carton 6 BX57041027CCBA 570 X 410 X 265 1.0 1.0 1 7 8 9 - 整箱總重量 (Total LCD Weight in carton): 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray x no of tray 6 24 (2)Total LCM quantity in carton: quantity per box x no of boxes 24 6 144 (4)保利龍板 Polylon board Use empty tray 空盤 (1)多層薄膜 POF Put products into the tray (2)TRAY 盤 (4)保利龍板 Tray Polylon board ╢ (3)內盒 Tray stacking Product Box (5)外紙箱 Carton 特 記 事 項 (REMARK) 斜角 Detail B Tray 1 4.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.